

General Description

The 70N03 is the highest performance trench N-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The 70N03 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% avalanche tested
- Green Device Available

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current ¹	70	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current ¹	50	A
I_{DM}	Pulsed Drain Current ²	170	A
EAS	Single Pulse Avalanche Energy ³	85	mJ
I_{AS}	Avalanche Current	45	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	65	W
T_{STG}	Storage Temperature Range	-55 to 175	°C
T_J	Operating Junction Temperature Range	-55 to 175	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient ¹	---	70	°C/W
$R_{\theta JC}$	Thermal Resistance Junction -Case ¹	---	2	°C/W

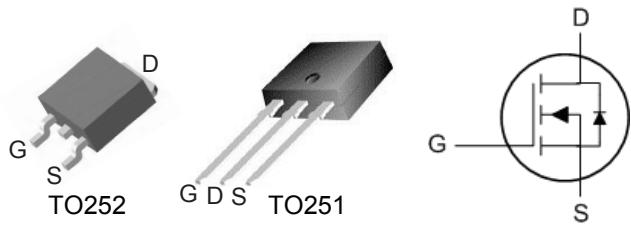
Product Summery

BVDSS	RDSON	ID
30V	7mΩ	70A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

TO252 / TO251 Pin Configuration



Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	30	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	BVDSS Temperature Coefficient	Reference to 25°C , $I_D=1\text{mA}$	---	6.5	---	$\text{mV}/^\circ\text{C}$
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance ²	$V_{GS}=10\text{V}$, $I_D=20\text{A}$	---	5.3	7	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}$, $I_D=20\text{A}$	---	7.5	11.5	
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu\text{A}$	1.0	1.5	3	V
$\Delta V_{GS(\text{th})}$	$V_{GS(\text{th})}$ Temperature Coefficient		---	5.08	---	$\text{mV}/^\circ\text{C}$
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=20\text{V}$, $V_{GS}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=20\text{V}$, $V_{GS}=0\text{V}$, $T_J=150^\circ\text{C}$	---	---	10	
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=10\text{V}$, $I_D=15\text{A}$	---	29	---	S
R_g	Gate Resistance	$V_{DS}=0\text{V}$, $V_{GS}=0\text{V}$, f=1MHz	---	1.7	3.4	Ω
Q_g	Total Gate Charge	$V_{DS}=10\text{V}$, $V_{GS}=5\text{V}$, $I_D=30\text{A}$	---	16.6	25.5	nC
Q_{gs}	Gate-Source Charge		---	8.1	---	
Q_{gd}	Gate-Drain Charge		---	4.7	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=10\text{V}$, $V_{GS}=10\text{V}$, $R_G=3.3\Omega$	---	13	---	ns
T_r	Rise Time		---	6.7	---	
$T_{d(off)}$	Turn-Off Delay Time		---	22.5	---	
T_f	Fall Time		---	10.1	---	
C_{iss}	Input Capacitance	$V_{DS}=20\text{V}$, $V_{GS}=0\text{V}$, f=1MHz	---	2211	---	pF
C_{oss}	Output Capacitance		---	515	---	
C_{rss}	Reverse Transfer Capacitance		---	174	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current ¹	$V_G=V_D=0\text{V}$, Force Current	---	27	---	A
I_{SM}	Pulsed Source Current ²		---	---	100	A
V_{SD}	Diode Forward Voltage ²	$V_{GS}=0\text{V}$, $I_S=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1.3	V

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{DD}=30\text{V}$, $V_{GS}=10\text{V}$, $L=0.1\text{mH}$, $I_L=12\text{A}$